Small Signal MOSFET 20 V, Dual N-Channel, SC-88

ESD Protection

Features

- Small Footprint (2 x 2 mm)
- Low Gate Charge N–Channel Device
- ESD Protected Gate
- Same Package as SC-70 (6 Leads)
- AEC-Q101 Qualified and PPAP Capable NVJD4401N
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Load Power Switching
- Li-Ion Battery Supplied Devices
- Cell Phones, Media Players, Digital Cameras, PDAs
- DC–DC Conversion

MAXIMUM RATINGS (T_J = 25° C unless otherwise stated)

MAXIMUM NATINGO (1) = 25 C dilless otherwise stated)						
Parame	Symbol	Value	Unit			
Drain-to-Source Voltage	V _{DSS}	20	V			
Gate-to-Source Voltage	1		V _{GS}	±12	V	
Continuous Drain Current	I _D	0.63	А			
(Based on $R_{\theta JA}$)	State	T _A = 85°C	1	0.46		
Power Dissipation	Steady	$T_A = 25^{\circ}C$	PD	0.27	W	
(based on $R_{\theta JA}$)	(Based on $R_{\theta JA}$) State			0.14		
Continuous Drain Current	Steady State	$T_A = 25^{\circ}C$	I _D	0.91	А	
(Based on $R_{\theta JL}$)	Sidle	T _A = 85°C		0.65		
Power Dissipation				0.55	W	
(Based on R _{θJL})	$T_A = 85^{\circ}C$	PD	0.29			
Pulsed Drain Current	I _{DM}	±1.2	А			
Operating Junction and Storage Temperature			T _J , T _{STG}	–55 to 150	°C	
Continuous Source Curre	۱ _S	0.63	А			
Lead Temperature for So (1/8" from case for 10 s)	Τ _L	260	°C			

THERMAL RESISTANCE RATINGS (Note 1)

Parameter	Symbol	Тур	Max	Units
Junction-to-Ambient - Steady State	R_{\thetaJA}	400	458	°C/W
Junction-to-Lead (Drain) - Steady State	R_{\thetaJL}	194	252	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

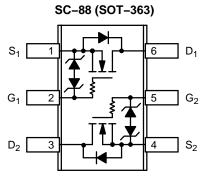
1. Surface mounted on FR4 board using 1 oz Cu area = 0.9523 in sq.



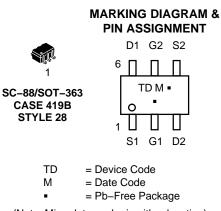
ON Semiconductor®

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V _{(BR)DSS}	R _{DS(on)} Typ	I _D Max	
20 V	0.29 Ω @ 4.5 V	0.63 A	
	0.36 Ω @ 2.5 V	0.03 A	



Top View



(Note: Microdot may be in either location)

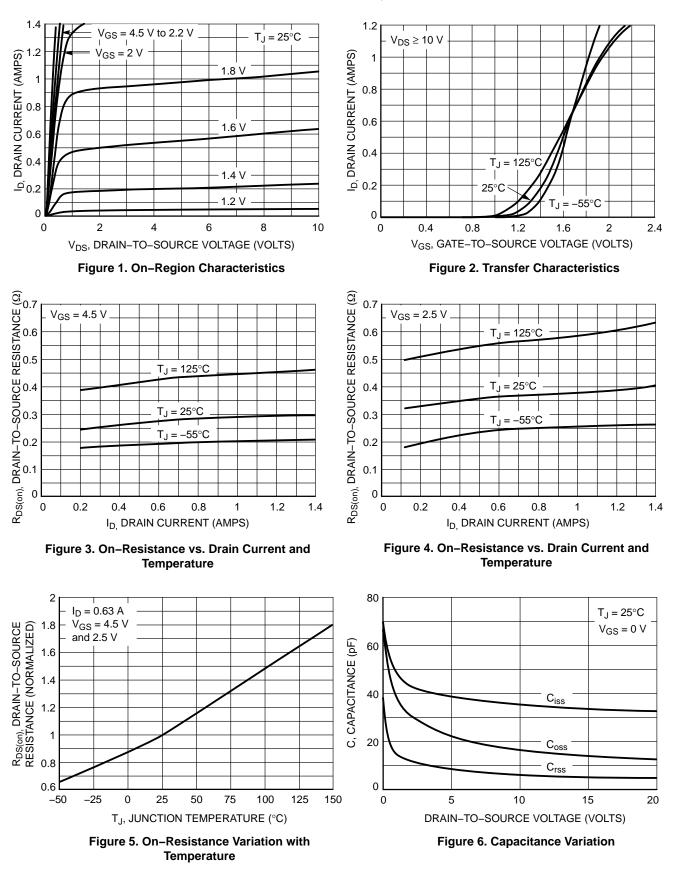
ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise stated)

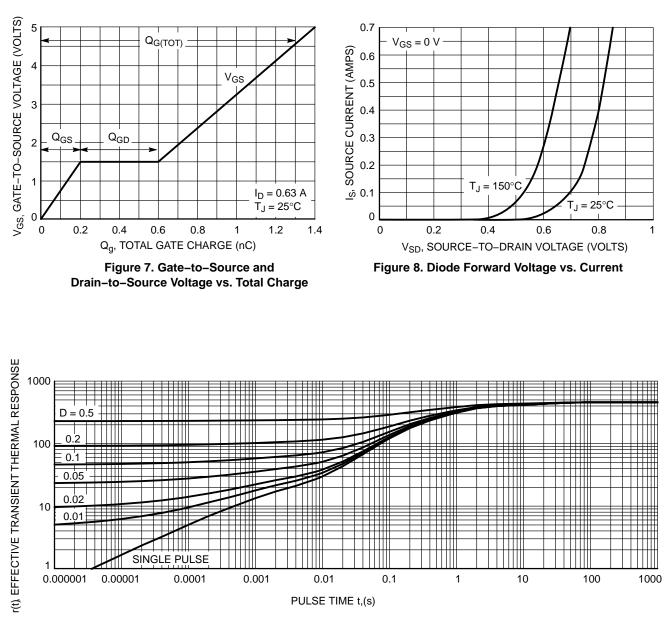
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	•	-			-	-	•
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 V, I_D = 250 \mu A$		20	27		V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				22		mV/ °C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _I	_{DS} = 16 V			1.0	μΑ
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{G}$	_{iS} = ±12 V			10	μA
ON CHARACTERISTICS (Note 2)						-	
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_{D}$	= 250 μA	0.6	0.92	1.5	V
Gate Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-2.1		mV/ °C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 4.5 V, I _I	_D = 0.63 A		0.29	0.375	Ω
		V_{GS} = 2.5 V, I _D = 0.40 A			0.36	0.445	
Forward Transconductance	9fs	V _{DS} = 4.0 V, I _D = 0.63 A			2.0		S
CHARGES AND CAPACITANCES						-	
Input Capacitance	C _{ISS}				33	46	pF
Output Capacitance	C _{OSS}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = 20 V			13	22	
Reverse Transfer Capacitance	C _{RSS}		v _{DS} = 20 v		2.8	5.0	
Total Gate Charge	Q _{G(TOT)}				1.3	3.0	nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V	ns = 10 V,		0.1		
Gate-to-Source Charge	Q _{GS}	$I_{\rm D} = 0.6$			0.2		
Gate-to-Drain Charge	Q _{GD}		Γ		0.4		
SWITCHING CHARACTERISTICS (No	ote 3)						
Turn–On Delay Time	td _(ON)				0.083		μs
Rise Time	tr	V _{GS} = 4.5 V, V	חם = 10 V,		0.227		
Turn–Off Delay Time	td _(OFF)	$I_{\rm D} = 0.5 \text{ A}, \text{ R}_{\rm G} = 20 \Omega$			0.786		
Fall Time	tf				0.506		
DRAIN-SOURCE DIODE CHARACTE	RISTICS						
Forward Diode Voltage	V _{SD}	$V_{GS} = 0 V,$	$T_J = 25^{\circ}C$		0.76	1.1	V
		I _S =0.23 A	T _J = 125°C		0.63		
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 \text{ V}, \text{ dI}_S/\text{dt} = 100 \text{ A}/\mu\text{s},$ $I_S = 0.63 \text{ A}$			0.410		μs

Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.



TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

TYPICAL PERFORMANCE CURVES ($T_J = 25^{\circ}C$ unless otherwise noted)





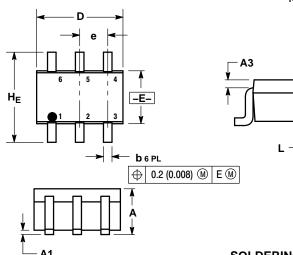
ORDERING INFORMATION

Device	Package	Shipping [†]
NTJD4401NT1G	SC-88 (Pb-Free)	3000 / Tape & Reel
NVJD4401NT1G	SC–88 (Pb–Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

SC-88/SC70-6/SOT-363 CASE 419B-02 ISSUE W



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M. 1982.

Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

3. 419B-01 OBSOLETE, NEW STANDARD 419B-02.

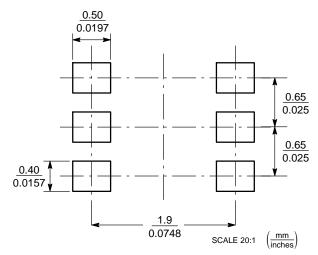
	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.80	0.95	1.10	0.031	0.037	0.043
A1	0.00	0.05	0.10	0.000	0.002	0.004
A3	0.20 REF			0.008 REF		
b	0.10	0.21	0.30	0.004	0.008	0.012
С	0.10	0.14	0.25	0.004	0.005	0.010
D	1.80	2.00	2.20	0.070	0.078	0.086
Е	1.15	1.25	1.35	0.045	0.049	0.053
е	0.65 BSC			0.026 BSC		
L	0.10	0.20	0.30	0.004	0.008	0.012
HE	2.00	2.10	2.20	0.078	0.082	0.086
STYLE 26:						
PIN 1. SOURCE 1						
	2. GATE 1					
	3 DRAIN 2					

4. SOURCE 2

5. GATE 2 6. DRAIN 1

0. DIVAIN I

SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

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